KPD-3224CGCK

3.2 x 2.4 mm SMD Chip LED Lamp



- The Green source color devices are made with AIGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.2 x 2.4 mm SMD LED, 2.4 mm thickness
- Low power consumption
- · Ideal for backlight and indicator
- · Package: 1500 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- · RoHS compliant

APPLICATIONS

- Backlight
- Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

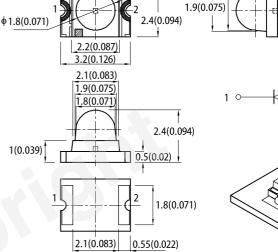
SELECTION GUIDE

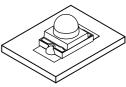
ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS

Polarity mark



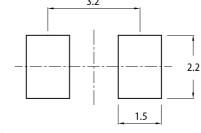


P.C. B<u>oar</u>d

1.8(0.071)

RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1) 3.2



Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.1(0.004") unless otherwise noted. 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

	Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
				Min.	Тур.	201/2	
	KPD-3224CGCK	Green (AlGalnP)	Water Clear	500	900	20°	

Notes

 $1, \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity / luminous flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

KPD-3224CGCK

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Denemeter	0. matrix at	Englithing Only	Value		Unit
Parameter	Symbol	Emitting Color	Тур. І		
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	Green	574	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Green	570	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Green	20	-	nm
Capacitance	С	Green	15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Green	2.1	2.5	V
Reverse Current ($V_R = 5V$)	I _R	Green	-	10	μΑ
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	$TC_{\lambda peak}$	Green	0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC _{λdom}	Green	0.08	-	nm/°C
Temperature Coefficient of $~V_F$ I_F = 20mA, -10 $^{\circ}C \leq T \leq 85 ^{\circ}C$	TCv	Green	-1.9	-	mV/°C

Notes:

Notes: 1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.) 2. Forward voltage: ±0.1V. 3. Wavelength value is traceable to CIE127-2007 standards. 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	75	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	30	mA
Peak Forward Current	Ι _{FM} ^[1]	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	710	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th JS}$ ^[2]	530	°C/W

Notes

Nores: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th JA}, R_{th JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

Forward Current vs.

Forward voltage (V)

Forward Voltage

T_a = 25 °C

50

40

30

20

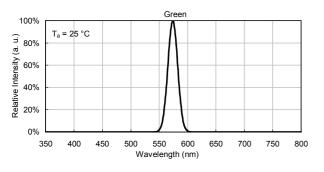
10

0

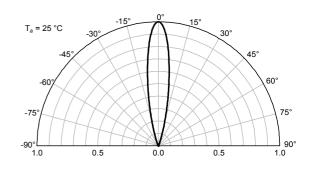
1.5 1.7 1.9 2.1 2.3

Forward current (mA)

RELATIVE INTENSITY vs. WAVELENGTH



SPATIAL DISTRIBUTION





Luminous Intensity vs.

Forward Current

T_a = 25 °C

10 20 30

Forward current (mA)

40 50

2.5

2.0

1.5

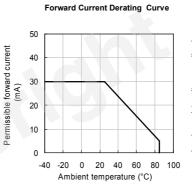
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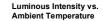
0.5

0.0

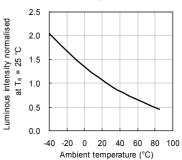
0

Luminous intensity normalised at 20 mA



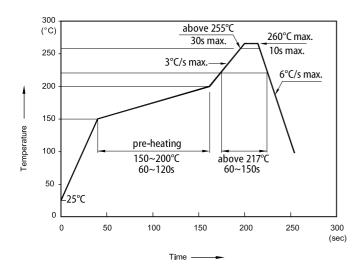


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REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

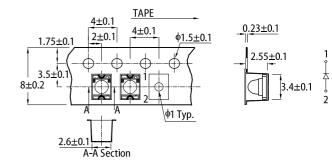
2.5



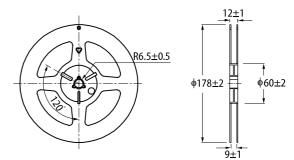
Notes

- Don't cause stress to the LEDs while it is exposed to high temperature.
 The maximum number of reflow soldering passes is 2 times.
 Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units:mm)

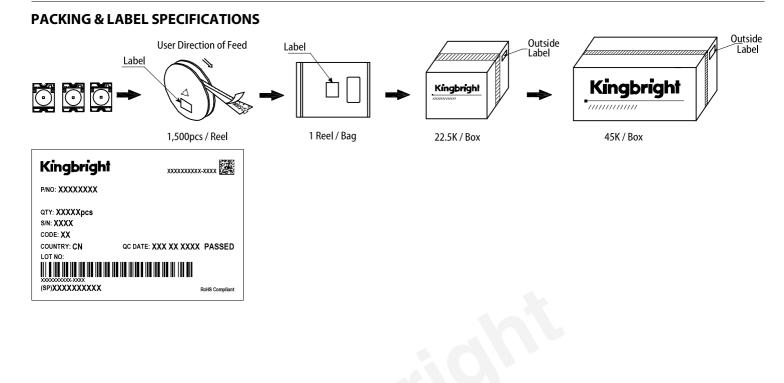


REEL DIMENSION (units : mm)



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KPD-3224CGCK



PRECAUTIONARY NOTES

- 1. 2.
- RECAUTIONARY NOTES
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 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
 the latest datasheet for the updated specifications.
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